imall

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10A, 35V - 150V Dual Common Cathode Schottky Rectifiers

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- Guardring for overvoltage protection
- High surge current capability

MECHANICAL DATA

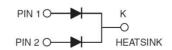
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21







TO-263AB (D²PAK)



Case: TO-263AB (D²PAK) Molding compound, UL flammability classification rating 94V-0 Moisture sensitivity level: level 1, per J-STD-020 Part No. with suffix "H" means AEC-Q101 qualified Packing code with suffix "G" means green compound (halogen-free) Terminal: Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 2 whisker test Polarity: As marked Weight: 1.37 g (approximately)

		MBRS	MBRS	MBRS	MBRS	MBRS	MBRS	MBRS	
PARAMETER	SYMBOL	1035	1045	1050	1060	1090	10100	10150	UNIT
		СТ	СТ	СТ	СТ	СТ	СТ	СТ	
Maximum repetitive peak reverse voltage	V _{RRM}	35	45	50	60	90	100	150	V
Maximum RMS voltage	V _{RMS}	24	31	35	42	63	70	105	V
Maximum DC blocking voltage	V _{DC}	35	45	50	60	90	100	150	V
Maximum average forward rectified current	I _{F(AV)}	10					А		
Peak repetitive forward current (Rated VR, Square wave, 20KHz)	I _{FRM}	10					А		
Peak forward surge current, 8.3 ms single half si superimposed on rated load	ne-wave I _{FSM}		120				А		
Peak repetitive reverse surge current (Note 1)	I _{RRM}				1				А
Maximum instantaneous forward voltage (Note 2 $I_F = 5 \text{ A}, T_J = 25^{\circ}\text{C}$.70		80		85	0.88	
I _F = 5 A, T _J =125°C	V _F		.57		65		75	0.78	V
I _F = 10 A, T _J =25°C I _F = 10 A, T _J =125°C			.80		90		95	0.98	
		0.	.67	0.	75	0.	85	0.88	
T _J =25°	C	0.1							
Maximum reverse current @ rated V_R T _J =100	°C I _R	1	15	1	0		-		mA
T _J =125	°C		-		5				
Voltage rate of change (Rated V_R)	dV/dt	10000					V/µs		
Typical thermal resistance	R _{θJC}	2					°C/W		
Operating junction temperature range	TJ	- 55 to +150					°C		
Storage temperature range	T _{STG}		- 55 to +150				°C		

Note 2: Pulse test with PW=300µs, 1% duty cycle



MBRS1035CT - MBRS10150CT

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ORDERING INFORMATION

PART NO.	PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING
	SUFFIX		SUFFIX ^(*)		
MBRS10xxCT	Ц	RN	G	D ² PAK	800 / 13" Paper reel
(Note 1) MN		D PAK	800 / 13" Plastic reel		

Note 1: "xx" defines voltage from 35V (MBRS1035CT) to 150V (MBRS10150CT)

*: Optional available

EXAMPLE						
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
MBRS1060CTHRNG	MBRS1060CT	Н	RN	G	AEC-Q101 qualified Green compound	

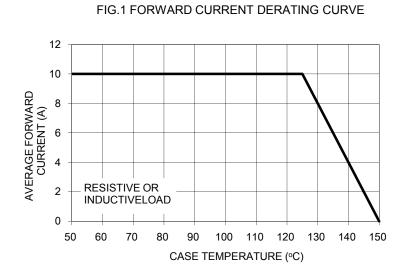
30

0

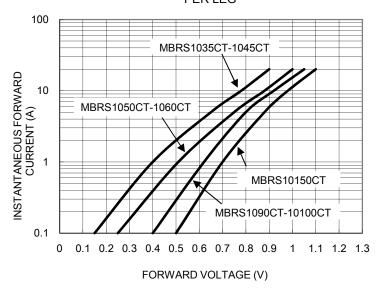
1

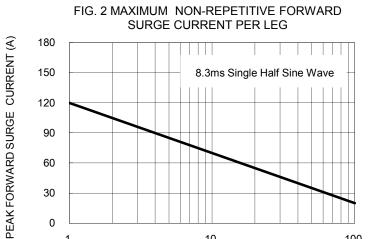
RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)









10 NUMBER OF CYCLES AT 60 Hz

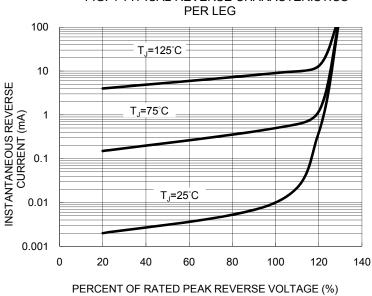


FIG. 4 TYPICAL REVERSE CHARACTERISTICS

100

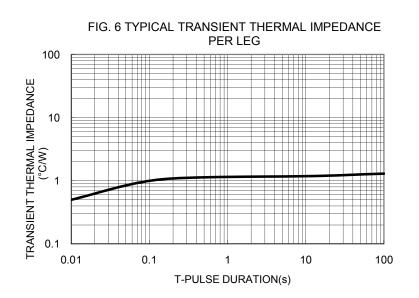


MBRS1035CT - MBRS10150CT

Taiwan Semiconductor

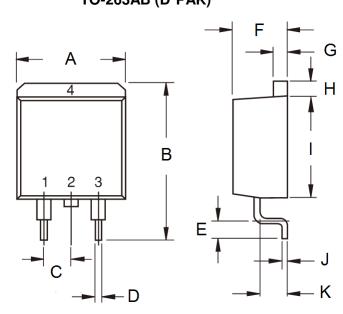
1000 900 f=1.0MHz 800 JUNCTION CAPACITANCE (pF) Vsig=50mVp-p 700 600 500 400 300 200 100 0 0.1 10 100 1 REVERSE VOLTAGE (V)

FIG. 5 TYPICAL JUNCTION CAPACITANCE

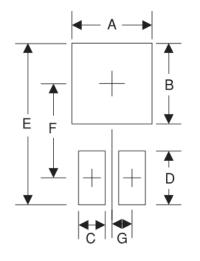


DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min	Мах	Min	Max	
А	-	10.5	-	0.413	
В	14.60	15.88	0.575	0.625	
С	2.41	2.67	0.095	0.105	
D	0.68	0.94	0.027	0.037	
E	2.29	2.79	0.090	0.110	
F	4.44	4.70	0.175	0.185	
G	1.14	1.40	0.045	0.055	
Н	1.14	1.40	0.045	0.055	
I	8.25	9.25	0.325	0.364	
J	0.36	0.53	0.014	0.021	
К	2.03	2.79	0.080	0.110	

PACKAGE OUTLINE DIMENSIONS TO-263AB (D²PAK)



SUGGESTED PAD LAYOUT



P/N

G

F

Symbol	Unit (mm)	Unit (inch)
A	10.8	0.425
В	8.3	0.327
С	1.1	0.043
D	3.5	0.138
E	16.9	0.665
F	9.5	0.374
G	2.5	0.098

MARKING DIAGRAM



- = Specific Device Code
- = Green Compound
- YWW = Date Code
 - = Factory Code

Document Number: DS_D1410061



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